

http://www.uniconn.cn/html/Page/A1003.html

PRODUCT SPECIFICATION

PRODUCT SERIES NAME: A1003 SERIES-DUAL ROW SMT TYPE

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1.SCOPE:

This specification covers the requirements for product performance of 1.00mm pitch wire to board connector series.

2.CONSTRUCTION • DIMENSIONS • MATERIAL & PLATING:

See the attached drawings

3.RATINGS & APPLICABLE WIRES:

Item	Standard		
Rated Voltage (max.)	50V AC, DC		
Rated Current (max.)	AWG #28	1A AC, DC	Insulation O.D.
and Applicable Wires	AWG #30	1A AC, DC	0.80mm (max.)
	AWG #32	0.5A AC, DC	
Ambient Temperature Range	$-25^{\circ}C \sim +85^{\circ}C^*$		

*: Including terminal temperature rise

4.PERFORMANCE:

4-1.ELECTRICAL PERFORMANCE

Test Description		Procedure	Requirement	
4-1-1	Contact	Mate connectors, measure by dry circuit, 20mV max.	$20 \mathrm{m}\Omega$ max.	
	Resistance	10mA. (Based upon JIS C5402 5.4)		
4-1-2	Insulation	Mate connectors, apply 500V DC between adjacent		
	Resistance	terminal or ground. (Based upon JIS C5402 5.2/	$100M\Omega$ min.	
		MIL-STD-202 Method 302 Cond. B)		
4-1-3	Dielectric	Mate connectors, apply 500V AC (rms) for 1 minute		
	Withstanding between adjacent terminal or ground. (Based upon		No Breakdown	
	Voltage	JIS C5402 5.1/MIL-STD-202 Method 301)		
4-1-4	Contact	Crimp the applicable wire on to the terminal, measure		
	Resistance	by dry circuit, 20mV max., 10mA.	$5m\Omega$ max.	
	on Crimped		JIIISZ IIIAX.	
	Portion			

			APPROVED	CHECKED	WRITTEN
			BY	BY	BY
A1	REVISE	2007.07.20	Wu Yu Chun	Lui Can Zhu	Bo Bo Chu
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4-2.MECHANICAL PERFORMANCE

Test	Description	Procedure		Requirement
4-2-1	Insertion &			Requirement
4-2-1		25 ± 3 mm/minute.		Refer to paragraph 5
4-2-2	Crimping	Fix the crimped terminal, apply axial	AWG #28	1.6kgf min.
			AWG #30	0.8kgf min.
			AWG #32	0.5kgf min.
4-2-3	Terminal Insertion Force	Insert the crimped terminal into the housing.		0.5kgf max.
4-2-4	Terminal/ Housing Retention Force	Apply axial pull out force at the speed rate of 25 ± 3 mm/minute on the terminal assembled in the housing.		0.5kgf min.
4-2-5	Pin Retention Force	Apply axial push force at the speed rate of 25 ± 3 mm/minute.		0.5kgf min.
4-2-6	Durability	When mated up to 50 cycles repeatedlyContactby the rate of 10 cycles per minute.Resistance		40mΩ max.
		Amplitude:1.5mm P-PSweep time:10-55-10 Hz in 1 minute	Appearance	No Damage
4-2-7 Vibration	Vibration	Duration: 2 hours in each X.Y.Z. axes	Contact Resistance	$40 \mathrm{m}\Omega$ max.
		(Based upon MIL-STD-202 Method 201A)	Discontinuity	1µsec. max.
		490m/s ² {50G}, 3 strokes in each X.Y.Z. axes.	Appearance	No Damage
4-2-8	Physical Shock	(Based upon JIS C0041/MIL-STD-202 Method 213B Cond. A)	Contact Resistance	$40 \mathrm{m}\Omega$ max.
			Discontinuity	1µsec. max.

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4-3.ENVIRONMENTAL PERFORMANCE AND OTHERS

Test Description Procedure			Requirement	
4-3-1	Temperature Rise	Carrying rated current load. (Based upon UL 498)	Temperature Rise	30°C max.
4-3-2	Heat	$85 \pm 2^{\circ}$ C, 96 hours	Appearance	No Damage
	Resistance	(Based upon JIS C0021/MIL-STD-202 Method 108A Cond. A)		$40\mathrm{m}\Omega$ max.
4-3-3	Cold	$-25 \pm 3^{\circ}$ C, 96 hours	Appearance	No Damage
	Resistance	(Based upon JIS C0020)	Contact Resistance	$40 \mathrm{m}\Omega$ max.
		Temperature: $40 \pm 2^{\circ}C$	Appearance	No Damage
		Relative Humidity: 90 ~ 95% Duration: 96 hours	Contact Resistance	$40 \mathrm{m}\Omega$ max.
4-3-4	Humidity	(Based upon JIS C0022/MIL-STD-202 Method 103B Cond. B)	Insulation Resistance	$10M\Omega$ min.
			Dielectric Withstanding Voltage	Must meet 4-1-3
4-3-5	Temperature	5 cycles of: a) - 55°C 30 minutes	Appearance	No Damage
	Cycling	b) +85°C 30 minutes (Based upon JIS C0025)	Contact Resistance	$40 \mathrm{m}\Omega$ max.
4-3-6	Salt Spray	24 ± 4 hours exposure to a salt spray from the $5 \pm 1\%$ solution at $35 \pm 2^{\circ}$ C.	Appearance	No Damage
	1 5	(Based upon JIS C0023/MIL-STD-202 Method 101D Cond. B)	Contact Resistance	$40 \mathrm{m}\Omega$ max.
		24 hours exposure to 50 ± 5 ppm.	Appearance	No Damage
4-3-7	SO ₂ Gas	SO ₂ gas at $40 \pm 2^{\circ}$ C.	Contact Resistance	$40\mathrm{m}\Omega$ max.
		40 minutes exposure to NH ₃ gas	Appearance	No Damage
4-3-8	NH ₃ Gas	evaporating from 28% Ammonia solution.	Contact Resistance	$40 \mathrm{m}\Omega$ max.
4-3-9	Solderability	Soldering Time: 5 ± 0.5 sec. Solder Temperature: $245 \pm 5^{\circ}C$	Solder Wetting	95% of immersed area must show no voids, pin holes
4-3-10	Resistance to Soldering Heat	When reflowingRefer to paragraph 6Solder iron methodSoldering Time: 5 ± 0.5 sec.Solder Temperature: $370^{\circ}C \sim 400^{\circ}C$	Appearance	No Damage

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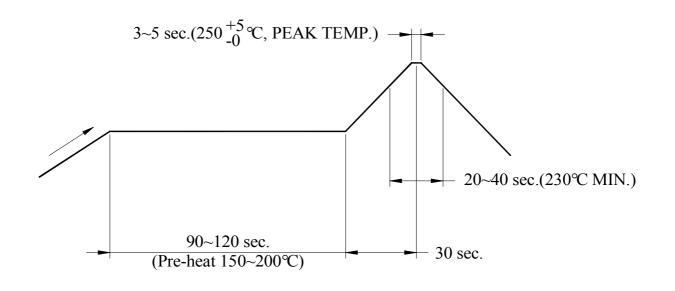
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5.INSERTION/WITHDRAWAL FORCE:

No. of	Insertion	Withdrawal	
circuits	(kgf max.)	(kgf min.)	
Single	0.2	0.04	
2X20	5.0	1.00	





TEMPERATURE CONDITION GRAPH (TEMPERATURE ON BOARD PATTERN SIDE)

NOTE: Please check the mount condition(reflow soldering condition) by your own devices beforehand, because the condition changes by the soldering devices, p.c.boards, and so on. No moisture treatment before reflow process.